PATENT APPLICATION TRANSMITTAL LETTER

(Large Entity)

Docket No. ITL.0947US (P15971)

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith for filing under 35 U.S.C. 111 and 37 C.F.R. 1.53 is the patent application of: Joseph M. Steigerwald For: Electrochemically Polishing Conductive Films on Semiconductor Wafers Enclosed are: Certificate of Mailing with Express Mail Mailing Label No. EL 990 136 896 US 1 sheets of drawings. A certified copy of a application. Declaration Signed. Unsigned. Power of Attorney Information Disclosure Statement Preliminary Amendment Other: Assignment Documents.							31281 U.S. PTO 10/722801
CLAIMS AS FILED							
For	#Filed	#Allowed	#Extra		Rate		Fee
Total Claims	19	- 20 =	0	х	\$18.00		\$0.00
Indep. Claims	3	- 3 =	0	х	\$86.00		\$0.00
Multiple Dependent Claims (check if applicable)							\$0.00
BASIC FEE							\$770.00
TOTAL FILING FEE							\$770.00
 A check in the amount of \$770.00 to cover the filing fee is enclosed. The Director is hereby authorized to charge and credit Deposit Account No. 20-1504 as described below. □ Charge the amount of as filing fee. ☒ Credit any overpayment. ☒ Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17. □ Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b). 							
Dated: November 26, 2	2003		Tro 855 Hou (713	p, Prun 4 Katy 1ston, T 8) 468-8	ier & Hu, P Freeway, S Cexas <i>7</i> 7024	uite 100	